



Product Change Notification / JAON-28ACMH770

Date:

30-Jun-2020

Product Category:

16-Bit - Microcontrollers and Digital Signal Controllers, 32-bit Microcontrollers, Capacitive Touch Sensors, Ethernet Controllers, Sensor Fusion Hub

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4156.001 and 4156.002 Final Notice: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire for selected products available in 44L QFN (8x8x0.9mm), 28L QFN-S (6x6x0.9mm) and 28L QFN (6x6x0.9mm) packages at MTAI assembly site.

Affected CPNs:

[JAON-28ACMH770_Affected_CPN_06302020.pdf](#)

[JAON-28ACMH770_Affected_CPN_06302020.csv](#)

Notification Text:

PCN Status: Final notification

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire for selected products available in 44L QFN (8x8x0.9mm), 28L QFN-S (6x6x0.9mm) and 28L QFN (6x6x0.9mm) packages at MTAI assembly site.

Pre Change:

Using gold (Au) bond wire

Post Change:

Using palladium coated copper with gold flash (CuPdAu) bond wire

Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	Microchip Technology Thailand HQ (MTAI)	Microchip Technology Thailand HQ (MTAI)
Lead frame material	C194	C194
Bond wire material	Au wire	CuPdAu wire
Die attach material	3280	3280
Mold compound material	G700LTD	G700LTD

Impacts to Data Sheet: None

Change Impact:None

Reason for Change:To improve manufacturability by qualifying palladium coated copper with gold flash (CuPdAu) bond wire at MTAI assembly site.

Change Implementation Status:In Progress

Estimated First Ship Date:July 24, 2020 (date code: 2030)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	June 2020					July 2020			
Workweek	23	24	25	26	27	28	29	30	31
Qual Report Availability					X				
Final PCN Issue Date					X				
Estimated Implementation Date								X	

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History: June 30, 2020: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on July 24, 2020.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

[PCN_JAON-28ACMH770_Qual_Report.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

Affected Catalog Part Numbers (CPN)

ENC424J600-I/ML
ENC424J600T-I/ML
DSPIC33EP512GP504-E/ML
DSPIC33EP512MC204-E/ML
DSPIC33EP512MC504-E/ML
PIC24EP512GP204-E/ML
PIC24EP512MC204-E/ML
DSPIC33EP512GP504-I/ML
DSPIC33EP512MC204-I/ML
DSPIC33EP512MC504-I/ML
PIC24EP512GP204-I/ML
PIC24EP512MC204-I/ML
DSPIC33EP512GP504T-H/ML
DSPIC33EP512MC204T-H/ML
DSPIC33EP512MC504T-H/ML
PIC24EP512GP204T-H/ML
PIC24EP512MC204T-H/ML
DSPIC33EP512GP504-H/ML
DSPIC33EP512MC204-H/ML
DSPIC33EP512MC504-H/ML
PIC24EP512GP204-H/ML
PIC24EP512MC204-H/ML
DSPIC33EP512GP504T-I/ML
DSPIC33EP512MC204T-I/ML
DSPIC33EP512MC504T-I/ML
PIC24EP512GP204T-I/ML
PIC24EP512MC204T-I/ML
DSPIC33EP512MC204T-E/ML
DSPIC33EP512MC504T-E/ML
PIC24EP512GP204T-E/ML
PIC24EP512MC204T-E/ML
DSPIC33EP64GP504-E/ML
DSPIC33EP64MC204-E/ML
DSPIC33EP64MC504-E/ML
PIC24EP64GP204-E/ML
PIC24EP64MC204-E/ML
DSPIC33EP64GP504-I/MLA3
DSPIC33EP64GP504-I/ML
DSPIC33EP64MC204-I/ML
DSPIC33EP64MC504-I/ML
PIC24EP64GP204-I/ML
PIC24EP64MC204-I/ML
DSPIC33EP64GP504T-H/ML
DSPIC33EP64MC204T-H/ML
DSPIC33EP64MC504T-H/ML
PIC24EP64GP204T-H/ML

JAON-28ACMH770 - CCB 4156.001 and 4156.002 Final Notice: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire for selected products available in 44L QFN (8x8x0.9mm), 28L QFN-S (6x6x0.9mm) and 28L QFN (6x6x0.9mm) packages at MTAI assembly site.

PIC24EP64MC204T-H/ML

DSPIC33EP64GP504-H/ML

DSPIC33EP64MC204-H/ML

DSPIC33EP64MC504-H/ML

PIC24EP64GP204-H/ML

PIC24EP64MC204-H/ML

DSPIC33EP64GP504T-I/ML

DSPIC33EP64MC204T-I/ML

DSPIC33EP64MC504T-I/ML

PIC24EP64GP204T-I/ML

PIC24EP64MC204T-I/ML

DSPIC33EP64GP504T-E/ML

DSPIC33EP64MC204T-E/ML

DSPIC33EP64MC504T-E/ML

PIC24EP64GP204T-E/ML

PIC24EP64MC204T-E/ML

DSPIC33EP128GP504-E/ML

DSPIC33EP128MC204-E/ML

DSPIC33EP128MC504-E/ML

PIC24EP128GP204-E/ML

PIC24EP128MC204-E/ML

DSPIC33EP128GP504-I/ML

DSPIC33EP128MC204-I/ML

DSPIC33EP128MC504-I/ML

PIC24EP128GP204-I/ML

PIC24EP128MC204-I/ML

DSPIC33EP128MC504T-H/ML

DSPIC33EP128GP504-H/ML

DSPIC33EP128MC204-H/ML

DSPIC33EP128MC504-H/ML

PIC24EP128GP204-H/ML

PIC24EP128MC204-H/ML

DSPIC33EP128GP504T-I/ML

DSPIC33EP128MC204T-I/ML

DSPIC33EP128MC504T-I/ML

PIC24EP128GP204T-I/ML

PIC24EP128MC204T-I/ML

DSPIC33EP128GP504T-E/ML

DSPIC33EP128MC204T-E/ML

DSPIC33EP128MC504T-E/ML

DSPIC33EP256GP504-E/ML

DSPIC33EP256MC204-E/ML

DSPIC33EP256MC504-E/ML

PIC24EP256GP204-E/ML

PIC24EP256MC204-E/ML

HA7619-I/ML027

DSPIC33EP256GP504-I/ML

DSPIC33EP256MC204-I/ML

DSPIC33EP256MC504-I/ML

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PIC24EP256GP204-I/ML

PIC24EP256MC204-I/ML

DSPIC33EP256GP504T-H/ML

DSPIC33EP256MC204T-H/ML

DSPIC33EP256MC504T-H/ML

PIC24EP256GP204T-H/ML

PIC24EP256MC204T-H/ML

DSPIC33EP256GP504-H/ML

DSPIC33EP256MC204-H/ML

DSPIC33EP256MC504-H/ML

PIC24EP256GP204-H/ML

PIC24EP256MC204-H/ML

HA7619T-I/ML025

HA7619T-I/ML027

PIC24EP256GP204T-I/ML029

DSPIC33EP256GP504T-I/ML

DSPIC33EP256MC204T-I/ML

DSPIC33EP256MC504T-I/ML

PIC24EP256GP204T-I/ML

PIC24EP256MC204T-I/ML

DSPIC33EP256MC204T-E/MLC02

DSPIC33EP256GP504T-E/ML

DSPIC33EP256MC204T-E/ML

DSPIC33EP256MC504T-E/ML

PIC24EP256GP204T-E/ML

PIC24EP256MC204T-E/ML

DSPIC33EP32GP504-E/ML

DSPIC33EP32MC204-E/ML

DSPIC33EP32MC504-E/ML

PIC24EP32GP204-E/ML

PIC24EP32MC204-E/ML

DSPIC33EP32GP504-I/ML

DSPIC33EP32MC204-I/ML

DSPIC33EP32MC504-I/ML

PIC24EP32GP204-I/ML

PIC24EP32MC204-I/ML

DSPIC33EP32GP504T-H/ML

DSPIC33EP32MC204T-H/ML

DSPIC33EP32MC504T-H/ML

PIC24EP32GP204T-H/ML

PIC24EP32MC204T-H/ML

DSPIC33EP32GP504-H/ML

DSPIC33EP32MC204-H/ML

DSPIC33EP32MC504-H/ML

PIC24EP32GP204-H/ML

PIC24EP32MC204-H/ML

DSPIC33EP32GP504T-I/ML

DSPIC33EP32MC204T-I/ML

DSPIC33EP32MC504T-I/ML

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PIC24EP32GP204T-I/ML
PIC24EP32MC204T-I/ML
DSPIC33EP32GP504T-E/ML
DSPIC33EP32MC204T-E/ML
DSPIC33EP32MC504T-E/ML
PIC24EP32GP204T-E/ML
PIC24EP32MC204T-E/ML
WP200TX01-E/ML001
DSPIC33EP64GS504-E/MLC06
DSPIC33EP64GS504-E/ML
DSPIC33EP32GS504-E/ML
DSPIC33EP16GS504-E/ML
DSPIC33EP32GS504-I/MLC09
DSPIC33EP32GS504-I/MLC10
DSPIC33EP64GS504-I/MLC11
DSPIC33EP64GS504-I/ML
DSPIC33EP32GS504-I/ML
DSPIC33EP16GS504-I/ML
DSPIC33EP32GS504T-I/MLC09
DSPIC33EP32GS504T-I/MLC10
DSPIC33EP64GS504T-I/MLC11
DSPIC33EP64GS504T-I/ML
DSPIC33EP32GS504T-I/ML
DSPIC33EP16GS504T-I/ML
WP200TX01T-E/ML001
DSPIC33EP64GS504T-E/ML
DSPIC33EP32GS504T-E/ML
DSPIC33EP16GS504T-E/ML
DSPIC33EP128GM304-E/ML
DSPIC33EP128GM604-E/ML
DSPIC33EP256GM304-E/ML
DSPIC33EP256GM604-E/ML
DSPIC33EP512GM304-E/ML
DSPIC33EP512GM604-E/ML
DSPIC33EP128GM304-I/ML
DSPIC33EP128GM604-I/ML
DSPIC33EP256GM304-I/ML
DSPIC33EP256GM604-I/ML
DSPIC33EP512GM304-I/ML
DSPIC33EP512GM604-I/ML
DSPIC33EV128GM004-E/ML
DSPIC33EV128GM104-E/ML
DSPIC33EV64GM004-E/ML
DSPIC33EV64GM104-E/ML
DSPIC33EV32GM004-E/ML
DSPIC33EV32GM104-E/ML
DSPIC33EV128GM004-I/ML
DSPIC33EV128GM104-I/ML
DSPIC33EV64GM004-I/ML

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DSPIC33EV64GM104-I/ML
DSPIC33EV32GM004-I/ML
DSPIC33EV32GM104-I/ML
DSPIC33EV128GM004-H/ML
DSPIC33EV128GM104-H/ML
DSPIC33EV64GM004-H/ML
DSPIC33EV64GM104-H/ML
DSPIC33EV32GM004-H/ML
DSPIC33EV32GM104-H/ML
DSPIC33EV128GM004T-I/ML
DSPIC33EV128GM104T-I/ML
DSPIC33EV64GM004T-I/ML
DSPIC33EV64GM104T-I/ML
DSPIC33EV32GM004T-I/ML
DSPIC33EV32GM104T-I/ML
DSPIC33EV256GM004-E/ML
DSPIC33EV256GM104-E/ML
DSPIC33EV256GM004-I/ML
DSPIC33EV256GM104-I/ML
DSPIC33EV256GM004-H/ML
DSPIC33EV256GM104-H/ML
DSPIC33EV256GM004T-I/ML
DSPIC33EV256GM104T-I/ML
PIC24FJ128GB204-E/ML
PIC24FJ64GB204-E/ML
PIC24FJ128GB204-I/ML
PIC24FJ64GB204-I/ML
PIC24FJ128GB204T-I/ML
PIC24FJ64GA204-E/ML
PIC24FJ128GA204-I/ML
PIC24FJ64GA204-I/ML
PIC24FJ128GA204T-I/ML
PIC24FJ64GA204T-I/ML
PIC32MX174F256D-I/ML
PIC32MX274F256D-I/ML
PIC32MX154F128D-I/ML
PIC32MX254F128D-I/ML
PIC32MX174F256D-V/ML
PIC32MX274F256D-V/ML
PIC32MX154F128D-V/ML
PIC32MX254F128D-V/ML
PIC32MX174F256DT-V/ML
PIC32MX274F256DT-V/ML
PIC32MX154F128DT-V/ML
PIC32MX254F128DT-V/ML
PIC32MX174F256DT-I/ML
PIC32MX274F256DT-I/ML
PIC32MX154F128DT-I/ML
PIC32MX254F128DT-I/ML

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MTCH6301-I/ML

PIC32MX120F032D-I/ML

PIC32MX110F016D-I/ML

PIC32MX220F032D-I/ML

PIC32MX210F016D-I/ML

PIC32MX120F032D-V/ML

PIC32MX110F016D-V/ML

PIC32MX220F032D-V/ML

PIC32MX210F016D-V/ML

PIC32MX120F032DT-V/ML

PIC32MX110F016DT-V/ML

PIC32MX220F032DT-V/ML

PIC32MX210F016DT-V/ML

MTCH6301T-I/ML

PIC32MX120F032DT-I/ML

PIC32MX110F016DT-I/ML

PIC32MX220F032DT-I/ML

PIC32MX210F016DT-I/ML

PIC32MX120F032D-50I/ML

PIC32MX220F032D-50I/ML

PIC32MX120F032DT-50I/ML

PIC32MX220F032DT-50I/ML

PIC32MX150F128D-I/ML

PIC32MX130F064D-I/ML

PIC32MX250F128D-I/ML

PIC32MX230F064D-I/ML

PIC32MX150F128D-V/ML

PIC32MX130F064D-V/ML

PIC32MX250F128D-V/ML

PIC32MX230F064D-V/ML

PIC32MX150F128DT-V/ML

PIC32MX130F064DT-V/ML

PIC32MX250F128DT-V/ML

PIC32MX230F064DT-V/ML

PIC32MX250F128DT-I/ML026

PIC32MX150F128DT-I/ML

PIC32MX130F064DT-I/ML

PIC32MX250F128DT-I/ML

PIC32MX230F064DT-I/ML

PIC32MX150F128D-50I/ML

PIC32MX250F128D-50I/ML

PIC32MX150F128DT-50I/ML

PIC32MX250F128DT-50I/ML

PIC32MX170F256D-I/ML

PIC32MX270F256D-I/ML

PIC32MX170F256D-V/ML

PIC32MX270F256D-V/ML

PIC32MX170F256DT-V/ML

PIC32MX270F256DT-V/ML

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PIC32MX170F256DT-I/ML

PIC32MX270F256DT-I/ML

PIC32MX170F256D-50I/ML

PIC32MX270F256D-50I/ML

PIC32MX170F256DT-50I/ML

PIC32MX270F256DT-50I/ML

DSPIC33EP512GP502-E/MM

DSPIC33EP512MC202-E/MM

DSPIC33EP512MC502-E/MM

PIC24EP512GP202-E/MM

DSPIC33EP512GP502-I/MM

DSPIC33EP512MC202-I/MM

DSPIC33EP512MC502-I/MM

PIC24EP512GP202-I/MM

PIC24EP512MC202-I/MM

DSPIC33EP512GP502T-H/MM

DSPIC33EP512MC202T-H/MM

DSPIC33EP512MC502T-H/MM

PIC24EP512GP202T-H/MM

PIC24EP512MC202T-H/MM

DSPIC33EP512GP502-H/MM

DSPIC33EP512MC202-H/MM

DSPIC33EP512MC502-H/MM

PIC24EP512GP202-H/MM

PIC24EP512MC202-H/MM

DSPIC33EP512GP502T-I/MM

DSPIC33EP512GP502T-E/MM

DSPIC33EP512MC502T-E/MM

DSPIC33EP64GP502-E/MM

DSPIC33EP64MC202-E/MM

DSPIC33EP64MC502-E/MM

PIC24EP64GP202-E/MM

PIC24EP64MC202-E/MM

DSPIC33EP64GP502-I/MM

DSPIC33EP64MC202-I/MM

DSPIC33EP64MC502-I/MM

PIC24EP64GP202-I/MM

PIC24EP64MC202-I/MM

DSPIC33EP64GP502T-H/MM

DSPIC33EP64MC202T-H/MM

DSPIC33EP64MC502T-H/MM

PIC24EP64GP202T-H/MM

PIC24EP64MC202T-H/MM

DSPIC33EP64GP502-H/MM

DSPIC33EP64MC202-H/MM

DSPIC33EP64MC502-H/MM

PIC24EP64GP202-H/MM

PIC24EP64MC202-H/MM

DSPIC33EP64MC202T-I/MM

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DSPIC33EP64MC502T-I/MM
PIC24EP64GP202T-I/MM
PIC24EP64MC202T-I/MM
DSPIC33EP64GP502T-E/MM
DSPIC33EP64MC202T-E/MM
DSPIC33EP64MC502T-E/MM
PIC24EP64MC202T-E/MM
DSPIC33EP128MC202-E/MM
PIC24EP128GP202-E/MM
PIC24EP128GP202-I/MM038
DSPIC33EP128GP502-I/MM
DSPIC33EP128MC202-I/MM
DSPIC33EP128MC502-I/MM
PIC24EP128GP202-I/MM
PIC24EP128GP202T-I/MM038
DSPIC33EP128GP502T-I/MM
DSPIC33EP128MC202T-I/MM
DSPIC33EP128MC502T-I/MM
DSPIC33EP128MC502T-E/MM
DSPIC33EP128MC202T-E/MM
DSPIC33EP256GP502-E/MM
DSPIC33EP256MC202-E/MM
DSPIC33EP256MC502-E/MM
PIC24EP256GP202-E/MM
PIC24EP256MC202-E/MM
HA7619-I/MM028
DSPIC33EP256GP502-I/MM
DSPIC33EP256MC202-I/MM
DSPIC33EP256MC502-I/MM
PIC24EP256GP202-I/MM
PIC24EP256MC202-I/MM
DSPIC33EP256GP502T-H/MM
DSPIC33EP256MC202T-H/MM
DSPIC33EP256MC502T-H/MM
PIC24EP256GP202T-H/MM
PIC24EP256MC202T-H/MM
DSPIC33EP256GP502-H/MM
DSPIC33EP256MC202-H/MM
DSPIC33EP256MC502-H/MM
PIC24EP256GP202-H/MM
PIC24EP256MC202-H/MM
HA7619T-I/MM028
DSPIC33EP256GP502T-I/MM
DSPIC33EP256MC202T-I/MM
DSPIC33EP256MC502T-I/MM
PIC24EP256GP202T-I/MM
PIC24EP256MC202T-I/MM
DSPIC33EP256GP502T-E/MM
DSPIC33EP256MC202T-E/MM

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DSPIC33EP256MC202T-E/MM
PIC24EP256GP202T-E/MM
PIC24EP256MC202T-E/MM
PIC24EP32MC202-E/MM021
DSPIC33EP32GP502-E/MM
DSPIC33EP32MC202-E/MM
DSPIC33EP32MC502-E/MM
PIC24EP32GP202-E/MM
PIC24EP32MC202-E/MM
DSPIC33EP32GP502-I/MM
DSPIC33EP32MC202-I/MM
DSPIC33EP32MC502-I/MM
PIC24EP32GP202-I/MM
PIC24EP32MC202-I/MM
DSPIC33EP32MC202-H/MM
DSPIC33EP32GP502T-I/MM
DSPIC33EP32MC202T-I/MM
DSPIC33EP32MC502T-I/MM
PIC24EP32GP202T-I/MM
PIC24EP32MC202T-E/MM021
DSPIC33EP32GP502T-E/MM
DSPIC33EP32MC202T-E/MM
DSPIC33EP32MC502T-E/MM
PIC24EP32GP202T-E/MM
DSPIC33EP64GS402-E/MMC02
DSPIC33EP16GS502-E/MMC03
DSPIC33EP64GS502-E/MM
DSPIC33EP32GS502-E/MM
DSPIC33EP16GS502-E/MM
DSPIC33EP32GS402-I/MMC01
DSPIC33EP64GS402-I/MMC02
DSPIC33EP64GS502-I/MMC07
DSPIC33EP64GS502-I/MMC12
DSPIC33EP32GS402-I/MM
DSPIC33EP64GS502-I/MM
DSPIC33EP32GS502-I/MM
DSPIC33EP16GS502-I/MM
DSPIC33EP32GS402T-I/MMC01
DSPIC33EP64GS402T-I/MMC02
DSPIC33EP64GS502T-I/MMC07
DSPIC33EP64GS502T-I/MMC12
DSPIC33EP32GS402T-I/MM
DSPIC33EP64GS502T-I/MM
DSPIC33EP32GS502T-I/MM
DSPIC33EP16GS502T-I/MM
DSPIC33EP64GS402T-E/MMC02
DSPIC33EP64GS502T-E/MM
DSPIC33EP32GS502T-E/MM
DSPIC33EP16GS502T-E/MM

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DSPIC33EV128GM002-E/MM
DSPIC33EV128GM102-E/MM
DSPIC33EV64GM002-E/MM
DSPIC33EV64GM102-E/MM
DSPIC33EV32GM002-E/MM
DSPIC33EV32GM102-E/MM
DSPIC33EV128GM002-I/MM
DSPIC33EV128GM102-I/MM
DSPIC33EV64GM002-I/MM
DSPIC33EV64GM102-I/MM
DSPIC33EV32GM002-I/MM
DSPIC33EV32GM102-I/MM
DSPIC33EV128GM002-H/MM
DSPIC33EV128GM102-H/MM
DSPIC33EV64GM002-H/MM
DSPIC33EV64GM102-H/MM
DSPIC33EV32GM002-H/MM
DSPIC33EV32GM102-H/MM
DSPIC33EV128GM002T-I/MM
DSPIC33EV128GM102T-I/MM
DSPIC33EV64GM002T-I/MM
DSPIC33EV64GM102T-I/MM
DSPIC33EV32GM002T-I/MM
DSPIC33EV32GM102T-I/MM
DSPIC33EV256GM002-E/MM
DSPIC33EV256GM102-E/MM
DSPIC33EV256GM002-I/MM
DSPIC33EV256GM102-I/MM
DSPIC33EV256GM002-H/MM
DSPIC33EV256GM102-H/MM
DSPIC33EV256GM002T-I/MM
DSPIC33EV256GM102T-I/MM
PIC24FJ64GB202-E/MM
PIC24FJ128GB202-I/MM
PIC24FJ64GB202-I/MM
PIC24FJ128GB202T-I/MM
PIC24FJ64GB202T-I/MM
PIC24FJ128GA202-E/MM
PIC24FJ64GA202-E/MM
PIC24FJ128GA202-I/MM
PIC24FJ64GA202-I/MM
PIC24FJ128GA202T-I/MM
PIC24FJ64GA202T-I/MM
PIC32MX174F256B-I/MM
PIC32MX274F256B-I/MM
PIC32MX154F128B-I/MM
PIC32MX254F128B-I/MM
PIC32MX174F256B-V/MM
PIC32MX274F256B-V/MM

JAPON-28ACMH770 - CCB 4156.001 and 4156.002 Final Notice: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire for selected products available in 44L QFN (8x8x0.9mm), 28L QFN-S (6x6x0.9mm) and 28L QFN (6x6x0.9mm) packages at MTAI assembly site.

PIC32MX154F128B-V/MM
PIC32MX254F128B-V/MM
PIC32MX174F256BT-V/MM
PIC32MX274F256BT-V/MM
PIC32MX154F128BT-V/MM
PIC32MX254F128BT-V/MM
PIC32MX174F256BT-I/MM
PIC32MX274F256BT-I/MM
PIC32MX154F128BT-I/MM
PIC32MX254F128BT-I/MM
PIC32MX120F032B-I/ML
PIC32MX110F016B-I/ML
PIC32MX220F032B-I/ML
PIC32MX210F016B-I/ML
PIC32MX120F032B-V/ML
PIC32MX110F016B-V/ML
PIC32MX220F032B-V/ML
PIC32MX210F016B-V/ML
PIC32MX120F032BT-V/ML
PIC32MX110F016BT-V/ML
PIC32MX220F032BT-V/ML
PIC32MX210F016BT-V/ML
PIC32MX120F032BT-I/ML
PIC32MX110F016BT-I/ML
PIC32MX220F032BT-I/ML
PIC32MX210F016BT-I/ML
PIC32MX120F032B-50I/ML
PIC32MX220F032B-50I/ML
PIC32MX120F032BT-50I/ML
PIC32MX220F032BT-50I/ML
SSC7150-ML-AB0
SSC7150-ML-AB1
PIC32MX150F128B-I/ML
PIC32MX130F064B-I/ML
PIC32MX250F128B-I/ML
PIC32MX230F064B-I/ML
PIC32MX150F128B-V/ML
PIC32MX130F064B-V/ML
PIC32MX250F128B-V/ML
PIC32MX230F064B-V/ML
PIC32MX150F128BT-V/ML
PIC32MX130F064BT-V/ML
PIC32MX250F128BT-V/ML
PIC32MX230F064BT-V/ML
SSC7150-ML-AB0-TR
SSC7150-ML-AB1-TR
PIC32MX250F128BT-I/ML028
PIC32MX150F128BT-I/ML
PIC32MX130F064BT-I/ML

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PIC32MX250F128BT-I/ML

PIC32MX230F064BT-I/ML

PIC32MX150F128B-50I/ML

PIC32MX250F128B-50I/ML

PIC32MX150F128BT-50I/ML

PIC32MX250F128BT-50I/ML